

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

## **Product image**

















High-temperature-resistant, straight, 2-tier male connector for all common soldering methods. Optimised for automatic assembly. Packed in box or tape. 3.2 mm solder pin suitable for reflow and wave soldering. These male connectors can be labelled and coded.

### General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number o poles: 4, 90°, Solder pin length (I): 3.2 mm, tinned black, Box	
Order No.	<u>1988360000</u>	
Туре	S2L-SMT 3.50/04/90G 3.2SN BK BX INK	
GTIN (EAN)	4050118373127	
Qty.	222 pc(s).	
Product data	IEC: 160 V / 10 A	
	UL: 150 V / 10 A	
Packaging	Вох	



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# **Technical data**

### **Dimensions and weights**

Depth	14.2 mm	Depth (inches)	0.559 inch
Height	14.2 mm	Height (inches)	0.559 inch
Height of lowest version	10.8 mm	Net weight	1.292 g
Width	8.4 mm	Width (inches)	0.331 inch

### **System specifications**

Product family	OMNIMATE Signal - series B2L/S2L 3.50 - 2-row	Type of connection	Board connection	
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm	
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°	
Number of poles	4	Number of solder pins per pole	1	
Solder pin length (I)	3.2 mm Solder pin dimensions		d = 1.0 mm, Octagonal	
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm		
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm	
L1 in mm	3.5 mm	L1 in inches	0.138 inch	
Number of rows	2	Pin series quantity	2	
Touch-safe protection acc. to DIN VDE	Safe from back-of-hand	Touch-safe protection acc. to DIN VDE		
57 106	touch	0470	IP 10	
Can be coded	Yes	Plugging cycles	25	
Plugging force/pole, max.	3 N	Pulling force/pole, max.	6 N	

### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Insulation strength	≥ 10 <sup>8</sup> Ω
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact material	Copper alloy	Contact surface tinned	
Layer structure of solder connection 23 µm Ni / 57 µm		Layer structure of plug contact	
	glossy		25 μm Sn / 13 μm Ni
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
Temperature range, installation, min.	-30 °C	Temperature range, installation, max.	100 °C

### Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	10 A
Rated current, max. number of poles (Tu=20°C)	10 A	Rated current, min. number of poles (Tu=40°C)	9 A
Rated current, max. number of poles (Tu=40°C)	8.5 A	Rated voltage for surge voltage class / pollution degree II/2	160 V
Rated voltage for surge voltage class / pollution degree III/2	125 V	Rated voltage for surge voltage class / pollution degree III/3	50 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	1.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	1.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 77 A

### Rated data acc. to CSA

Rated voltage (Use group B / CSA)	150 V	Rated voltage (Use group C / CSA) 50 V
Rated voltage (Use group D / CSA)	150 V	Rated current (Use group B / CSA) 5 A
Rated current (Use group C / CSA)	9.5 A	Rated current (Use group D / CSA) 9.5 A

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# **Technical data**

Rated	data	acc.	to	UL	1059

Poted voltage (Llee group P. / III. 1050)	150 V	Poted ourrent /Llee group	P / III 1050\ 10 A
Rated voltage (Use group B / UL 1059)	150 V	Rated current (Use group	B / UL 1059) 10 A
Packing			
Packaging	Box	VPE length	35 mm
VPE width	145 mm	VPE height	340 mm
Important note			
IPC conformity	Conformity: The prod	lusts are developed, manufactured and deli	ivered according international recognized
ir C comorning	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.		
Notes	<ul> <li>Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months</li> </ul>		
Approvals			
ROHS	Conform		
Downloads			
User Documentation	NTI AAP13		



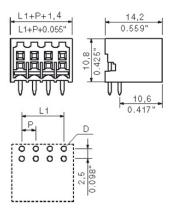
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# **Drawings**

## **Dimensional drawing**





## Recommended wave solderding profiles

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### Single Wave:



#### **Double Wave:**



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



## Recommended reflow soldering profile

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### Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.